

2 Channel Headset Microphone EMI Filter with ESD Protection

Product Description

The CSPEMI202FCTAG is a dual low-pass filter array integrating two pi-style filters (C-R-C) that reduce EMI/RFI emissions while at the same time providing ESD protection. This part is custom-designed to interface with a microphone port on a cellular telephone or similar device. Each high quality filter provides more than 35 dB attenuation in the 800–2700 MHz range. These pi-style filters support bidirectional filtering, controlling EMI both to and from a microphone element. They also support bipolar signals, enabling audio signals to pass through without distortion.

In addition, the CSPEMI202AG provides a very high level of protection for sensitive electronic components that may be subjected to electrostatic discharge (ESD). The diodes safely dissipate ESD strikes of ± 8 kV, the maximum requirement of the IEC 61000-4-2 international standard. Using the MIL-STD-883 (Method 3015) specification for Human Body Model (HBM) ESD, the device provides protection for contact discharges to greater than ± 15 kV.

The CSPEMI202FCTAG is particularly well-suited for portable electronics (e.g. cellular telephones, PDAs, notebook computers) because of its small package format and low weight. The CSPEMI202FCTAG is available in a space-saving, low-profile Chip Scale Package with RoHS compliant lead-free finishing.

Features

- Two Channels of EMI Filtering
- Pi-Style EMI Filters in a Capacitor-Resistor-Capacitor (C-R-C) Network
- Greater than 40 dB Attenuation at 1 GHz
- ± 8 kV ESD Protection on each Channel (IEC 61000-4-2 Level 4, Contact Discharge)
- ± 15 kV ESD Protection on each Channel (HBM)
- Supports Bipolar Signals – Ideal for Audio Applications
- Chip Scale Package Features Extremely Low Lead Inductance for Optimum Filter and ESD Performance
- 5-Bump, 0.930 x 1.410 mm Footprint Chip Scale Package (CSP)
- These Devices are Pb-Free and are RoHS Compliant

Applications

- EMI Filtering and ESD Protection for Headset Microphone Ports
- Wireless Handsets
- Handheld PCs / PDAs
- MP3 Players
- Digital Camcorders
- Notebooks
- Desktop PCs



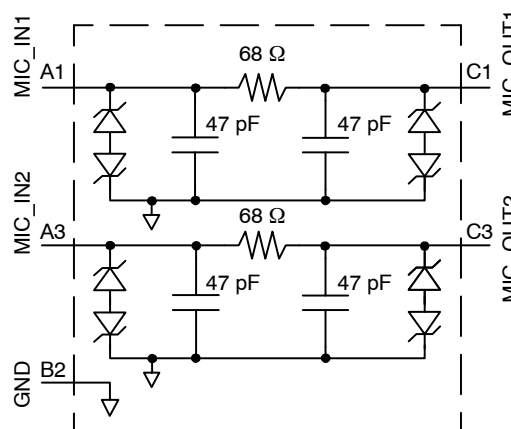
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WLCSP5
AG SUFFIX
CASE 567LT

ELECTRICAL SCHEMATIC



MARKING DIAGRAM



AE = CSPEMI202FC

ORDERING INFORMATION

Device	Package	Shipping [†]
CSPEMI202FCTAG	CSP-5 (Pb-Free)	3500 / Tape & Reel

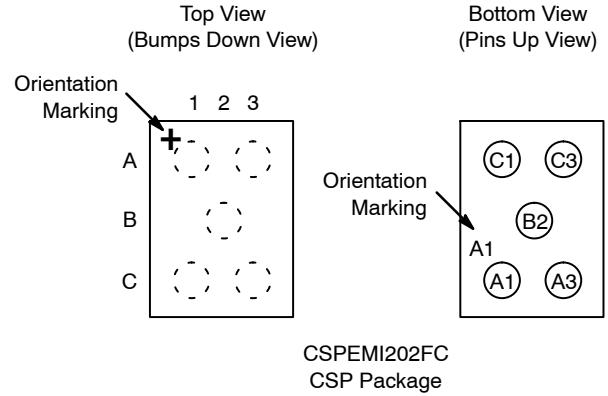
[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

CSPEMI202FCTAG

Table 1. PIN DESCRIPTIONS

5-bump CSP Package		
Pin	Name	Description
A1	MIC_IN1	Microphone Input 1 (from microphone)
A3	MIC_IN2	Microphone Input 2 (from microphone)
B2	GND	Device Ground
C1	MIC_OUT1	Microphone Output 1 (to audio circuitry)
C3	MIC_OUT1	Microphone Output 2 (to audio circuitry)

PACKAGE / PINOUT DIAGRAMS



SPECIFICATIONS

Table 2. ABSOLUTE MAXIMUM RATINGS

Parameter	Rating	Units
Storage Temperature Range	-65 to +150	°C
DC Power per Resistor	100	mW
DC Package Power Rating	200	mW

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

Table 3. STANDARD OPERATING CONDITIONS

Parameter	Rating	Units
Operating Temperature Range	-40 to +85	°C

Table 4. ELECTRICAL OPERATING CHARACTERISTICS (Note 1)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
R_1	Resistance		61	68	75	Ω
C_1	Channel Capacitance		76	94	112	pF
I_{LEAK}	Diode Leakage Current	$V_{IN} = 5.0 \text{ V}$			1.0	μA
V_{SIG}	Signal Voltage Positive Clamp Negative Clamp	$I_{LOAD} = 10 \text{ mA}$	5 -15	7 -10	15 -5	V
V_{ESD}	In-system ESD Withstand Voltage a) Human Body Model, MIL-STD-883, Method 3015 b) Contact Discharge per IEC 61000-4-2 Level 4	(Note 2)	± 15 ± 8			kV
V_{CL}	Clamping Voltage during ESD Discharge MIL-STD-883 (Method 3015), 8 kV Positive Transients Negative Transients	(Notes 2 and 3)		+15 -19		V
f_C	Cut-off frequency $Z_{SOURCE} = 50 \Omega$, $Z_{LOAD} = 50 \Omega$			60		MHz

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

- $T_A = 25^\circ\text{C}$ unless otherwise specified.
- ESD applied to input and output pins with respect to GND, one at a time.
- Clamping voltage is measured at the opposite side of the EMI filter to the ESD pin. For example, if ESD is applied to Pin A1, then clamping voltage is measured at Pin C1.

PERFORMANCE INFORMATION

Typical Filter Performance (nominal conditions unless specified otherwise, 50 Ω Environment)

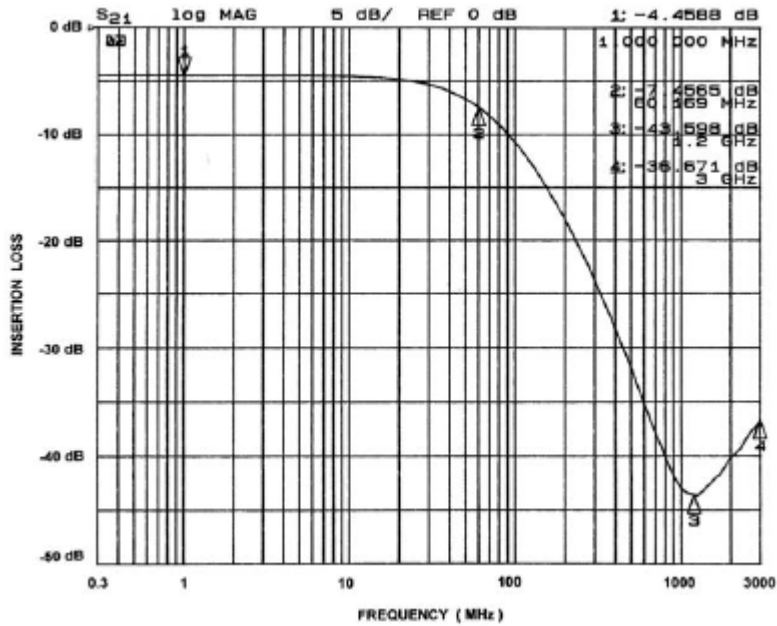


Figure 1. Insertion Loss vs. Frequency (A1-C1 to GND B2)

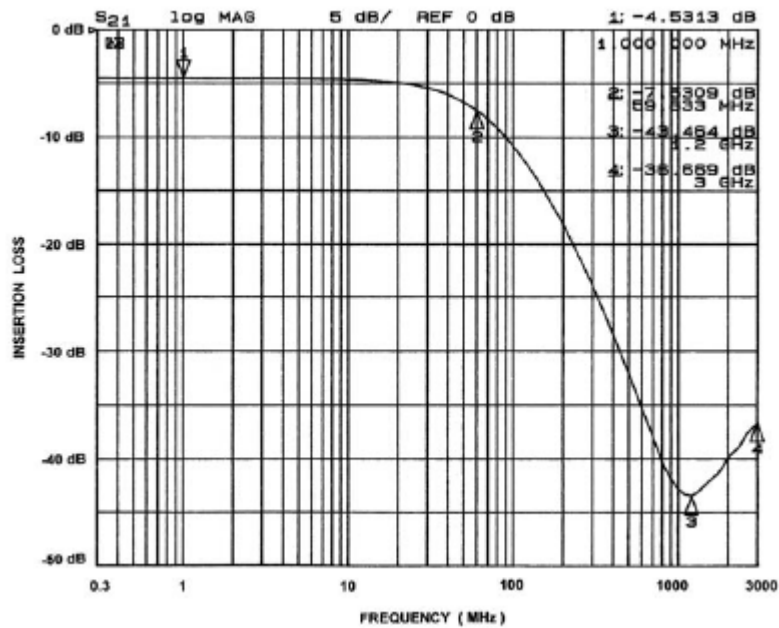


Figure 2. Insertion Loss vs. Frequency (A3-C3 to GND B2)

CSPEMI202FCTAG

APPLICATION INFORMATION

Parameter	Value
Pad Size on PCB	0.240 mm
Pad Shape	Round
Pad Definition	Non-Solder Mask defined pads
Solder Mask Opening	0.290 mm Round
Solder Stencil Thickness	0.125 mm – 0.150 mm
Solder Stencil Aperture Opening (laser cut, 5% tapered walls)	0.300 mm Round
Solder Flux Ratio	50/50 by volume
Solder Paste Type	No Clean
Pad Protective Finish	OSP (Entek Cu Plus 106A)
Tolerance – Edge To Corner Ball	$\pm 50 \mu\text{m}$
Solder Ball Side Coplanarity	$\pm 20 \mu\text{m}$
Maximum Dwell Time Above Liquidous	60 seconds
Maximum Soldering Temperature for Lead-free Devices using a Lead-free Solder Paste	260°C

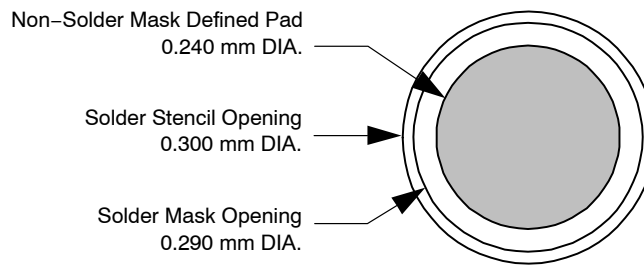


Figure 3. Recommended Non-Solder Mask Defined Pad Illustration

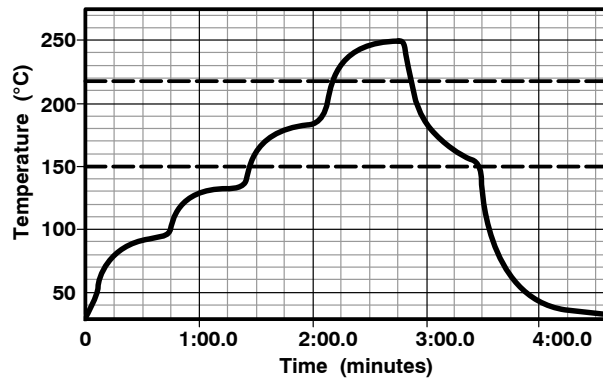


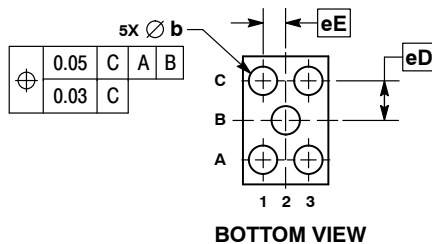
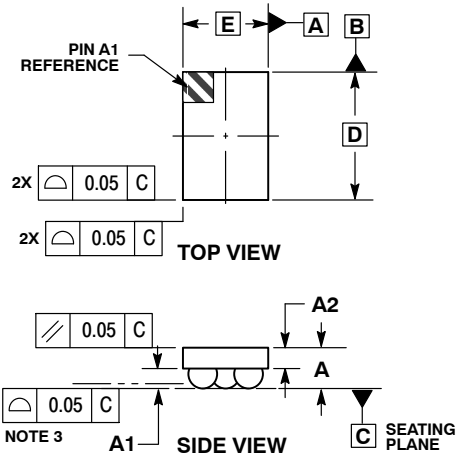
Figure 4. Lead-free (SnAgCu) Solder Ball Reflow Profile



SCALE 4:1

WLCSP5, 1.41x0.94
CASE 567LT
ISSUE 0

DATE 05 JUN 2015


NOTES:

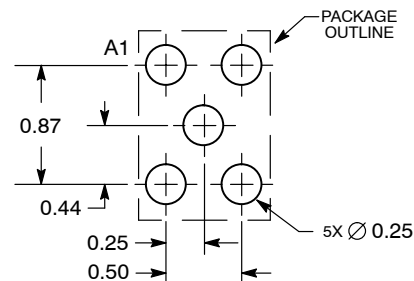
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. COPLANARITY APPLIES TO SPHERICAL CROWNS OF SOLDER BALLS.

DIM	MILLIMETERS	
	MIN	MAX
A	0.40	0.50
A1	0.21	0.27
A2	0.23	REF
b	0.29	0.35
D	1.41	BSC
E	0.94	BSC
eD	0.435	BSC
eE	0.25	BSC

GENERIC MARKING DIAGRAM*


X = Specific Device Code
M = Month Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present.

RECOMMENDED SOLDERING FOOTPRINT*


DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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